

Alloy Designation	
EN	CuNiSi
DIN	CuNiSi
UNS	C19010 ASTM B422 B888
JIS	C1901

Chemical Composition		
Ni	0.8 - 1.8	%
Si	0.15 - 0.35	%
Cu	Remainder	

Characteristics
C19010 is a precipitation-hardened Cu–Ni–Si alloy that combines elevated strength with good electrical and thermal conductivity. It is strengthened by Ni–Si precipitates formed during cold working and subsequent heat treatment, giving excellent formability and bendability while maintaining stable stress-relaxation performance (effective up to about 150 °C). The alloy shows good corrosion resistance—including resistance to stress-corrosion cracking—and offers reliable weldability, solderability and brazability.

Main Applications
Press-Fit terminal / Press-fit pin
Switches and relays contact blades contact springs
Connectors Semiconductor components
Junction boxes

Physical Properties (Reference values at room temperature)		
Density	g/cm ³	8.91
Electrical conductivity	IACS%(20°C)*	53
Modulus of elasticity	KN/mm ²	127
Coefficient of thermal expansion	10 ⁻⁶ /K	16.8
Thermal conductivity	W/(m*K)	255

*value for the lowest temper class

Mechanical Properties							
TEMPER		Tensile Strength Mpa	Yield Strength Mpa	Elongation %	Hardness HV	Bending Test(90°) GW BW	
R360	H01	360 - 430	min. 275	min. 8	100 - 130	0	0
R410	H02	410 - 470	min. 360	min. 7	120 - 155	0	0.5
R460	TM03	460 - 520	min. 340	min. 12	135 - 165	0	0.5
R490	TM04	490 - 560	min. 410	min. 10	140 - 170	0	0.5
R520	TM06	520 - 590	min. 440	min. 8	150 - 180	0.5	0.5
R580	TM08	580 - 655	min. 510	min. 6	160 - 210	1	1

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